



High Performance LVPECL Fanout Buffer

Features

- → 4 LVPECL Outputs
- → Up to 1.5GHz Output Frequency
- → Ultra Low Additive Phase Jitter: < 0.03 ps (typ) (differential 156.25MHz, 12KHz to 20MHz integration range)
- → Two selectable inputs
- → Low delay from input to output (Tpd typ. 1.5ns)
- \rightarrow 2.5V / 3.3V power supply
- → Industrial temperature support
- → Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- → Halogen and Antimony Free. "Green" Device (Note 3)
- → For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative.

https://www.diodes.com/guality/product-definitions/

→ Packaging (Pb-free & Green): □ 20-pin, TSSOP (L)

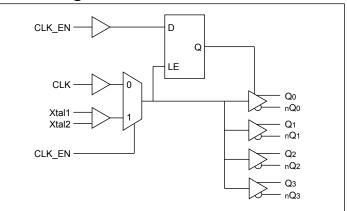
Applications

- → Networking systems including switches and Routers
- → High frequency backplane based computing and telecom platforms

Description

The PI6C4911504-03 is a high performance fanout buffer device which supports up to 1.5GHz frequency. PI6C4911504-03 features selectable single-ended clock or crystal inputs and translates to four LVPECL outputs. The outputs are synchronized with input clock during asynchronous assertion /deassertion of CLK EN pin. PI6C4911504-03 is ideal for crystal or LVCMOS/LVTTL to LVPECL translation. Typical clock translation and distribution applications are data-communications and telecommunications. This device is ideal for systems that need to distribute low jitter clock signals to multiple destinations.

Block Diagram



Notes:

^{1.} No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

^{2.} See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free. 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.





Pin Configuration

		-
V _{EE}	1 ⁰ 20	
CLK_EN	2 19	
	3 18	□ v _{cc}
CLK C	4 17	Q 1
NC E	5 16	D NQ1
Xtal ₁	6 15	🛛 Q2
Xtal ₂	7 14	D NQ2
NC E	8 13	□ v _{cc}
NC E	9 12	D Q3
V _{CC} [10 11	D NQ3
]

Pin Description

Pin #	Pin Name	Ту	pe	Description
1	V _{EE}	Power		Negative power supply
2	CLK_EN	Input	Pullup	Clock output enable/ disable
3	CLK_SEL	Input	Pulldown	Clock input source selection pin
4	CLK	Input	Pulldown	Clock input
5	NC	-		No Connect
6	XTAL1	Input		Xtal input
7	XTAL2	Output		Xtal output
8,9	NC	-		No connect
10, 13, 18	V _{CC}	Power		Power supply
11 12	nQ3	Outmut		LVPECL output clock
11, 12	Q3	Output		LV PECL output clock
14, 15	nQ2	Quitmut		LVPECL output clock
14, 15	Q2	Output		LV FECL output clock
16 17	nQ1	Quitmut		LVPECL output clock
16, 17	Q1	Output		LV FECL output clock
19, 20	nQ0	Quitaut		LVPECL output clock
17, 20	Q0	Output		LV FECL output clock

Note: Pullup and Pulldown are for internal input resistors

Function Table

Table 1: Clock source input select function

Table 2: Clock output select function

CLK_SEL	Function	CLK_EN	Function
0	CLK is the selected reference input	0	All outputs disabled. Qx disabled low, nQx disabled High
1	XTAL is the selected input	1	All outputs enabled.





Maximum Ratings (Above which the useful life may be impaired. For user guidelines, not tested)

Storage temperature55 to +150°C
Supply Voltage to Ground Potential (VCC)0.5 to +4.65V
Inputs (Referenced to GND)0.5 to Vcc+0.5V
Clock Output (Referenced to GND)0.5 to Vcc+0.5V
Soldering Temperature (Max of 10 seconds)+260°C
Latch up200mA
Junction TemperatureMax. 125°C

Note:

Stresses greater than those listed under MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

Power Supply Characteristics and Operating Conditions

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
V Cumply Voltage			3.135		3.465	V
V _{CC}	Supply Voltage		2.375		2.625	V
I _{DD}	Power Supply Current	All outputs unloaded			130	mA
T _A	Ambient Operating Temperature		-40		85	°C

DC Electrical Specifications - LVCMOS Inputs

Symbol	Parameter	Conditions		Min.	Тур.	Max.	Units
V _{IH}	Input high voltage		V _{CC} =3.3V	2.0		V _{CC} +0.3	V
V _{IL}	Input low voltage		V _{CC} =3.3V	-0.3		0.8	V
V _{IH}	Input high voltage		V _{CC} =2.5V	1.7		V _{CC} +0.3	V
V _{IL}	Input low voltage		V _{CC} =2.5V	-0.3		0.7	V
I _{IH} Input High current	In most II: -h	CLK, CLK_SEL				150	uA
	Input High current	CLK_EN				10	uA
т	Input I our current	CLK, CLK_SEL		-10			uA
I _{IL}	Input Low current	CLK_EN		-150			uA
C _{IN}	Input capacitance				4		pF
R _{pullup/pull-} down	Input pullup and pulldown resistor				50		kΩ

DC Electrical Specifications- LVPECL Outputs

Parameter	Description	Conditions	Min.	Тур.	Max.	Units
V _{OH} Output High voltage	Output II'sh sultan	V _{CC} =3.3V	2.1		2.6	v
	Output High voltage	V _{cc} =2.5V	1.3		1.75	
V _{OL} Output Low voltage	Output Louveltage	V _{CC} =3.3V	1.0		1.8	V
	Output Low voltage	V _{cc} =2.5V	0.4		0.8	v





AC Electrical Specifications – Differential Outputs

Parameter	Description	Conditions	Min.	Тур.	Max.	Units
F _{OUT}	Clock output frequency	LVPECL			1500	MHz
T _r	Output rise time	From 20% to 80%		150		ps
T _f	Output fall time	From 80% to 20%		150		ps
T _{ODC}	Output duty cycle		48		52	%
V _{PP}	Output swing Single-ended	LVPECL outputs	400			mV
T _j	Buffer additive jitter RMS			0.03		ps
T _{sk}	Output Skew	4 outputs devices, outputs in same bank, with same load, at DUT.		25		ps
T _{PD}	Propagation Delay			1500		ps
T _{od}	Valid to HiZ		200			ns
T _{oe}	HiZ to valid		200			ns

Notes:

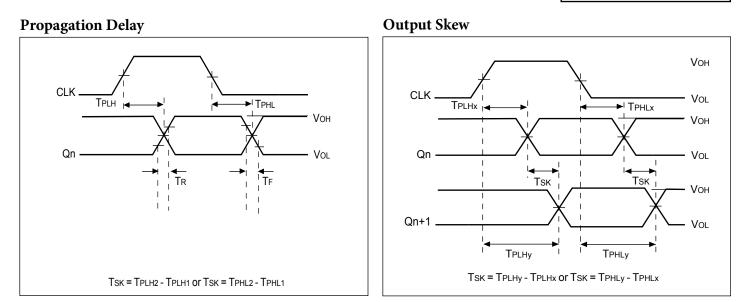
All parameters are measured with CMOS input of 266MHz unless stated otherwise

Crystal Characteristics

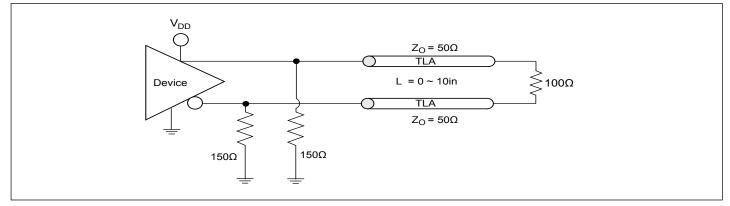
Parameters	Test Conditions	Min.	Тур.	Max.	Units
Mode of Oscillation		F	Fundamenta	al	
Frequency		12		50	MHz
Equivalent Series Resis- tance (ESR)				50	Ω
Shunt Capacitance				7	pF
Drive Level				1	mW







Configuration Test Load Board Termination for LVPECL



Part Marking

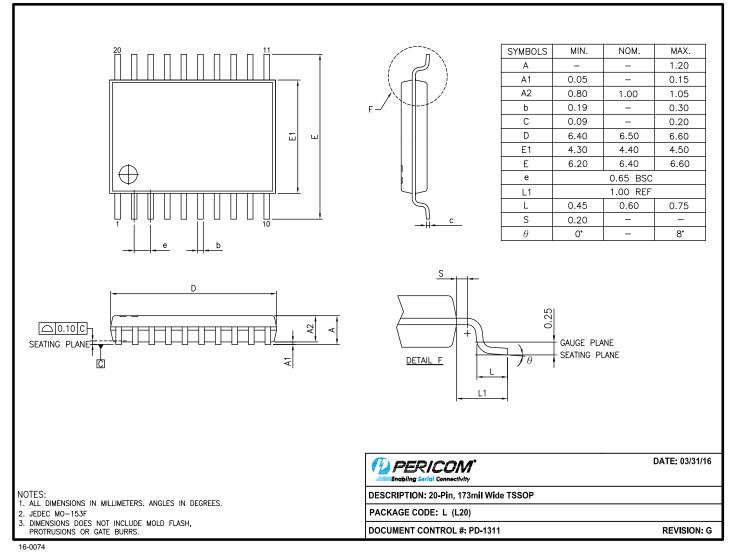


Z: Die Rev YY: Year WW: Workweek 1st X: Assembly Code 2nd X: Fab Code





Packaging Mechanical: 20-TSSOP (L)



For latest package info.

please check: http://www.diodes.com/design/support/packaging/pericom-packaging/packaging-mechanicals-and-thermal-characteristics/

Ordering Information

Ordering Number	Package Code	Package Description
PI6C4911504-03LIEX	L	20-Pin, 173mil Wide (TSSOP)

Notes:

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free. 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm

antimony compounds.

4. E = Pb-free and Green

5. X suffix = Tape/Reel





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